# DISCRETE CERAMICS

# DATA SHEET

PRC201 5%; 1% Power chip resistors size 1218

Product specification Supersedes data of 27th April 2001 2001 May 28 Rev.15



PRC201 5%; 1%

### **FEATURES**

- · Reduced size of final equipment
- · Low assembly costs
- Higher component and equipment reliability
- Excellent performance at high frequency.

### **APPLICATIONS**

- Power supplies in small sized equipment
- Camcorders
- Portable radio, CD and cassette players
- · Automotive.

### **DESCRIPTION**

The resistors are constructed on a high grade ceramic body (aluminium oxide). Internal metal electrodes are added at each end and connected by a resistive paste which is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance, by laser cutting of this resistive layer.

The resistive layer is covered with a protective coating and printed with the resistance value. Finally, the two external end terminations are added. To guarantee optimum solderability the outer layer consists of a lead-tin alloy.

### **QUICK REFERENCE DATA**

DESCRIPTION	VALUE
Resistance range	1Ω to $1$ $MΩ$
Resistance tolerance and series:	
$1 \Omega \le R \le 1 M\Omega$	±5%, ±1%; E24/E96 series
Temperature coefficient:	
1 Ω ≤ R < 10 Ω	$\leq \pm 200 \times 10^{-6} / K$
$10 \Omega \le R \le 1 M\Omega$	≤±100 × 10 <sup>-6</sup> /K
Absolute maximum dissipation at T <sub>amb</sub> = 70 °C	1 W
Maximum permissible voltage	200 V (DC or RMS)
Maximum permissible current	6 A (DC or RMS)
Operating temperature range	−55 °C to +155 °C
Basic specification	IEC 60115-8

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### **ORDERING INFORMATION**

Table 1 Ordering code indicating resistor type and packing

	TOL. (%)	ORDERING CODE 2322 735		
TYPE		BLISTER TAPE ON REEL		
		5000 units		
PRC201	±5	60		
	±1	2		
Jumper 0 $\Omega$				
PRC201; note 1	_	90006		

### Note

1. The jumper has a maximum resistance  $R_{max}$  = 20 m $\Omega$  and a rated current  $I_R$  = 6 A.

# Ordering code (12NC)

- The resistors have a 12-digit ordering code starting with 2322
- The subsequent four or five digits indicate the resistor type and packing; see Table 1.
- The remaining digits indicate the resistance value:
  - The first 2 digits for 5% or 3 digits for 1% tolerance products indicate the resistance value.
  - The last digit indicates the resistance decade in accordance with Table 2.

Table 2 Last digit of 12NC

RESISTANCE DECADE	LAST DIGIT
1 to 9.1 Ω	8
10 to 91 Ω	9
100 to 910 Ω	1
1 to 9.1 kΩ	2
10 to 91 kΩ	3
100 to 910 kΩ	4
1 ΜΩ	5

### **ORDERING EXAMPLE**

The ordering code of a PRC201 resistor, value 470  $\Omega$  with 5% tolerance, supplied on blister tape of 5 000 units per reel is: 2322 735 60471.

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### **FUNCTIONAL DESCRIPTION**

#### **Product characterization**

Standard values of nominal resistance are taken from the E24 or E96 series for resistors with a tolerance of  $\pm 5\%$  or  $\pm 1\%$ . The values of the E24/E96 series are in accordance with "IEC publication 60063".

# **Limiting values**

TYPE	LIMITING	LIMITING	LIMITING
	VOLTAGE <sup>(1)</sup>	CURRENT	POWER
	(V)	(A)	(W)
PRC201	200	6	1

#### Note

1. The maximum voltage that may be continuously applied to the resistor element, see "IEC publication 60115-8".

### **DERATING**

The power that the resistor can dissipate depends on the operating temperature; see Fig.1.

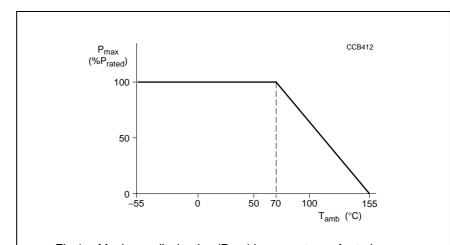
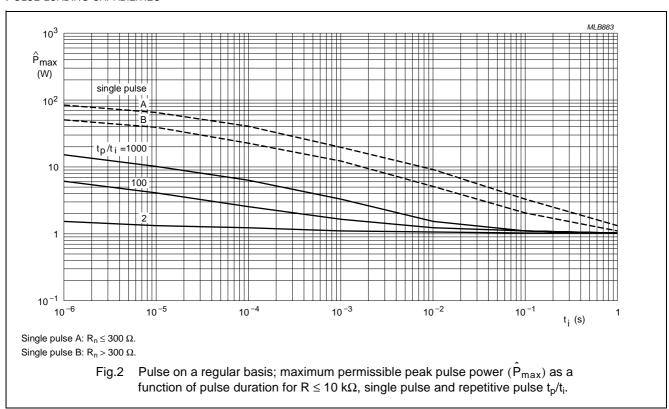


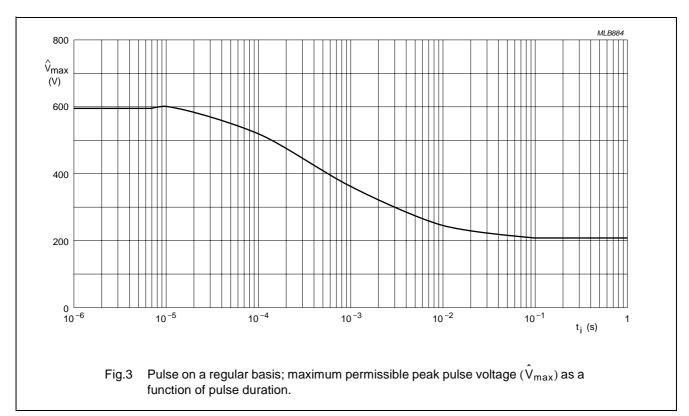
Fig.1 Maximum dissipation ( $P_{max}$ ) in percentage of rated power as a function of the ambient temperature ( $T_{amb}$ ).

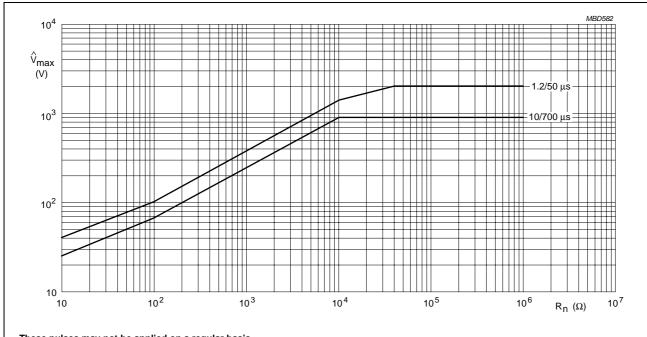
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### PULSE LOADING CAPABILITIES







These pulses may not be applied on a regular basis.

Fig.4 Maximum permissible peak pulse voltage without failing to 'open circuit' in accordance with DIN IEC 60040 (CO) 533.

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# **Application information**

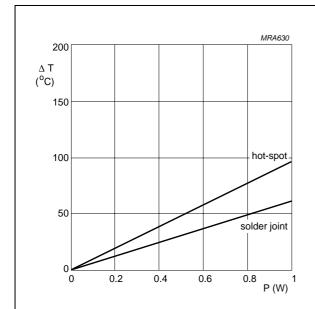


Fig.5 Temperature rise at hot-spot and solder joint as a function of dissipated power, for a resistor mounted horizontally on ceramic PCB.

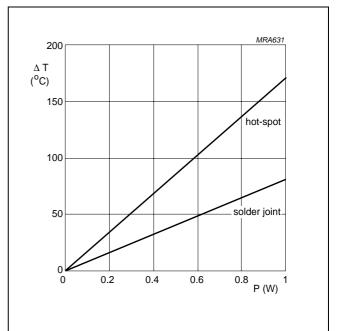


Fig.6 Temperature rise at hot-spot and solder joint as a function of dissipated power, for a resistor mounted horizontally on a FR4 PCB.

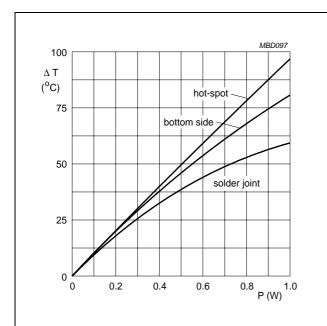
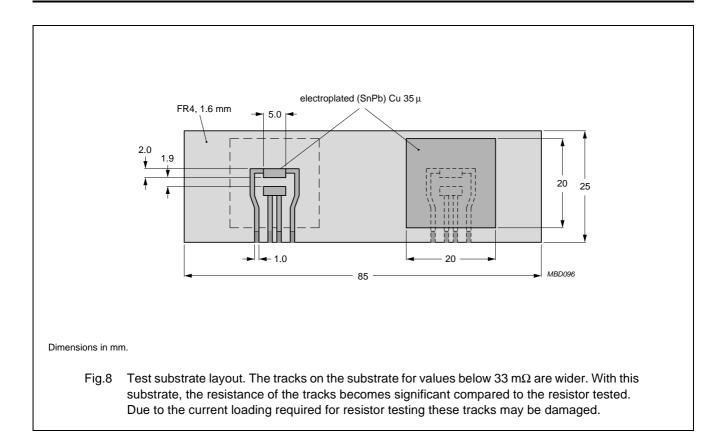


Fig.7 Temperature rise at hot-spot and solder joint as a function of dissipated power, for a resistor horizontally mounted on the test substrate; see Fig.8.

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### **MECHANICAL DATA**

### Mass per 100 units

TYPE	MASS (g)	
PRC201	3	

### Marking

Each resistor is marked with the nominal resistance value.

### 4-DIGIT MARKING

For values up to 910  $\Omega$  the R is used as a decimal point. For values of 1 k $\Omega$  or greater the letter K or M is used as the decimal point for the k $\Omega$  or M $\Omega$  indication.

# **Magnitude indicators**

RESISTANCE	INDICATOR
1 to 910 Ω	R
1 to 910 kΩ	K
1 ΜΩ	M

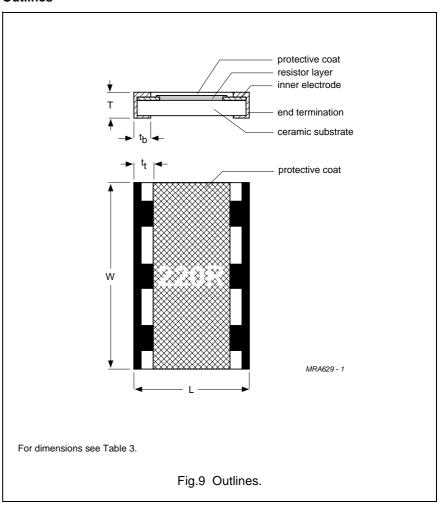
# Example

MARKING	RESISTANCE
120R	120 Ω
4K70	4.70 kΩ

# PACKAGE MARKING

The packing is also marked and includes resistance value, tolerance, catalogue number, quantity, production period, batch number and source code.

### **Outlines**



**Table 3** Chip resistor type and relevant physical dimensions; see Fig.9

TYPE	L	W	T	t <sub>t</sub>	t <sub>b</sub>
	(mm)	(mm)	(mm)	(mm)	(mm)
PRC201	3.05 ±0.15	4.60 ±0.20	0.55 ±0.10	0.45 ±0.25	0.50 ±0.25

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### **TESTS AND REQUIREMENTS**

Essentially all tests are carried out in accordance with the schedule of "IEC publication 60115-8", category 55/155/56 (rated temperature range –55 to +155 °C; damp heat, long term, 56 days).

The testing also covers the requirements specified by EIA and EIAJ.

The tests are carried out in accordance with IEC publication 60068, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions in accordance with "IEC 60068-1", subclause 5.3.

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C Relative humidity: 45% to 75% Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

In Table 4 the tests and requirements are listed with reference to the relevant clauses of "IEC publications 60115-8 and 60068", a short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

Table 4 Test procedures and requirements

IEC 60115-8 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
Tests in ac	cordance wi	th the schedule o	f IEC publication 60115-8	
4.4.1		visual examination		no holes; clean surface; no damage
4.4.2		dimensions	gauge	0.45 mm ≤ T ≤ 0.65 mm
		(outline)		4.4 mm ≤ W ≤ 4.8 mm
				$2.9 \text{ mm} \leq L \leq 3.2 \text{ mm}$
4.5		resistance	applied voltage (+0/-10%):	R – R <sub>nom</sub> : max. ±5% or 1%
			R < 10 Ω: 0.1 V	
			10 Ω ≤ R < 100 Ω: 0.3 V	
			100 Ω ≤ R < 1 kΩ: 1 V	
			1 kΩ ≤ R < 10 kΩ: 3 V	
			10 kΩ ≤ R < 100 kΩ: 10 V	
			100 kΩ ≤ R < 1 MΩ: 25 V	
			1 MΩ: 50 V	
4.18	20 (Tb)	resistance to	unmounted chips; 10 ±1 s; 260 ±5 °C:	
		soldering heat	$1 \Omega \le R \le 1 M\Omega$	$\Delta$ R/R max.: ±(1% +0.05 $\Omega$ )
4.29	45 (Xa)	component solvent resistance	isopropyl alcohol; H <sub>2</sub> O	no visible damage
4.17	20 (Ta)	solderability	unmounted chips completely immersed for 2 $\pm$ 0.5 s in a solder bath at 235 $\pm$ 2 °C	good tinning (≥95% covered); no damage
4.7		voltage proof on insulation	200 V (RMS) during 1 minute	no breakdown or flashover
4.13		short time overload		$\Delta$ R/R max.: ±(1% +0.05 $\Omega$ )

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IEC 60115-8 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS	
4.33		bending	resistors mounted on a 90 mm glass epoxy resin PCB (FR4), bending: 2 mm	no damage $\Delta$ R/R max.: $\pm$ (1% +0.05 $\Omega$ )	
4.19	14 (Na)	rapid change of temperature	30 minutes at LCT and 30 minutes at UCT; 5 cycles	no visible damage $\Delta$ R/R max.: $\pm$ (1.0% +0.05 $\Omega$ )	
4.6.1.1		insulation resistance	100 V (DC) after 1 minute	$R_{ins}$ min.: 1000 $MΩ$	
4.24.2	3 (Ca)	damp heat (steady state)	56 days; 40 ±2 °C; 93 +2/–3% RH; loaded with 0.01P <sub>n</sub>	no visible damage $\Delta$ R/R max.: $\pm$ (3% +0.1 $\Omega$ )	
4.25.1		endurance	1000 +48/–0 hours; 70 ±2 °C; loaded with P <sub>n</sub> or V <sub>max</sub> ; 1.5 hours on and 0.5 hours off:	no visible damage	
4.00.0	07 (D.)		$1 \Omega \le R \le 1 M\Omega$	$\Delta$ R/R max.: $\pm$ (3% +0.1 $\Omega$ )	
4.23.2	27 (Ba)	endurance at upper category temperature	1000 +48/-0 hours; no load	no visible damage $\Delta$ R/R max.: $\pm$ (3% +0.1 $\Omega$ )	
4.8.4.2s'		temperature	at 20/LCT/20 °C and 20/UCT/20 °C:		
		coefficient	1 Ω ≤ R < 10 Ω	$\Delta$ R/R max.: $\pm 200 \times 10^{-6}$ /K	
			10 Ω ≤ R	$\Delta$ R/R max.: $\pm 100 \times 10^{-6}$ /K	
Other tests	Other tests in accordance with IEC 60115 clauses and IEC 60068 test method				
4.17	20 (Ta)	solderability (after ageing)	16 hours steam or 16 hours at 155 $^{\circ}$ C; unmounted chips completely immersed for 2 $\pm$ 0.5 s in a solder bath at 235 $\pm$ 2 $^{\circ}$ C	good tinning (≥95% covered); no damage	
Other appl	icable tests				
		leaching	unmounted chips 60 ±1 s; 260 ±5 °C	good tinning; no leaching	

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# **REVISION HISTORY**

Revision	Date	Change Notification	Description
Rev. 14	2001 Apr 27	_	- Converted to Phycomp brand
Rev.15	2001 May 28	EBB-0176- 2000005/FD 2000 May 15	- 2% range discontinued